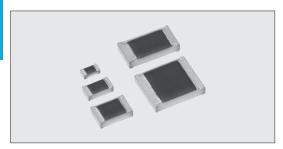


RN73R Metal Film Flat Chip Resistors (High reliability)



Coating color: Black

■Features

- SMD metal film resistors.
- High precision type $\pm 0.05\%$ is also available as standard.
- \bullet High performance T.C.R. $\pm 5\times 10^{-6}/K$ is also available as standard.
- · Low current noise.
- \bullet Operating temperature range ${\sim}155{^\circ}\!\mathrm{C}_{\,\cdot}$

Rated ambient temperature : $85^{\circ}\!\mathrm{C}$

- \bullet High reliability with ΔR of $\pm 0.1\% {\sim} \pm 0.25\%$ in the long-term reliability test.
- Endurance at 85°C (1,000h) : ΔR of $\pm 0.1\%$
- Improved moisture resistance by high humidity protective coating.
- Suitable for control circuits in various industrial equipment.
- Suitable for both flow and reflow solderings.
- Products meet EU-RoHS requirements.
- AEC-Q200 qualified.
- Sulfur resistance verified according to ASTM B 809-95.

Applications

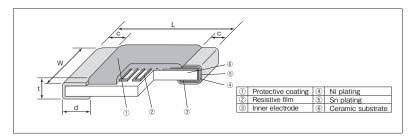
- Automotive electronics
- Industrial equipment
- Measurement equipment

 $\ensuremath{\mbox{\%}}$ For higher precision, RN73H series is available.

■Reference Standards

IEC 60115-8 JIS C 5201-8 EIAJ RC-2133A

■Construction



■Dimensions

Туре		Weight (g)				
(Inch Size Code)	L	W	С	d	t	(1000pcs)
1 E (0402)	1.0+0.1	0.5±0.05	0.25±0.1	0.25+0.05	0.35±0.05	0.68
1 J (0603)	1.6±0.2	0.8±0.1	0.3±0.1	0.3±0.1	0.45±0.1	2.14
2A (0805)	2.0±0.2	1.25±0.2	0.4±0.2	0.3+0.2	0.5±0.1	4.54
2B (1206)	3.2±0.2	1.6±0.2	0.5±0.3	0.4+0.2	0.6±0.1	9.14
2E(1210)	3.2±0.2	2.5±0.2	0.5±0.5	U.4 _{-0.1}	0.6±0.1	14.5

■Type Designation

Example

RN73R	2B	T	TD	1002	В	25
Product Code	Power Rating	Terminal Surface Material	Taping	Nominal Resistance	Resistance Tolerance	T.C.R. (×10 ⁻⁶ /K)
	1E:0.063W 1J:0.1W 2A:0.125W 2B:0.25W 2E:0.25W	T:Sn	TP:2mm pitch punch paper TD:4mm pitch paper TE:4mm pitch plastic embossed BK:Bulk	4 digits	A:±0.05% B:±0.1% C:±0.25% D:±0.5% F:±1%	05 10 25 50 100

Contact us when you have control request for environmental hazardous material other than the substance specified by EU-RoHS.

For further information on taping, please refer to APPENDIX C on the back pages.

■Ratings

Туре	Power Rating	, Ambient Terminai (🔀 1		T.C.R.	T.C.R. (×10 ⁻⁶ /K) Resistance Range (Ω) E24 · E96 · E192						Max. Overload	Taping & Q' ty/Reel (pcs)		
	naurig	Temp.	Part Temp.	(×10 7K)	A:±0.05%	B:±0.1%	C:±0.25%	D:±0.5%	F:±1%	Voltage	Voltage	TP	TD	TE
			±10	_	47~10k	47~10k	47~10k	47~10k						
1E	0.063W	85°C	90℃	±25	-	47~300k	47~300k	10~300k	10~300k	50V	100V	10,000	-	_
				±50	-	47~300k	47~300k	10~300k	10~300k					
				±5	100∼59k	100∼59k	_	_	_	75V	150V	-	5,000	-
			95℃	±10	47~59k	47~59k	47~59k	47~59k	47~59k					
1J	0.1W	85°C		±25	47~59k	15~1M	15~1M	10~1M	10~1M					
				±50	-	15~1M	15~1M	10~1M	10~1M					
				±100	-	-	-	10~1M	10~1M					
	2A 0.125W 85℃			±5	100~100k	100~100k	-	_	_					
				±10	47~100k	47~100k	47~100k	47~100k	47~100k					
2A		100°C	±25	47~100k	15~1.5M	15~1.5M	10~1.5M	10~1.5M	150V	300V	-	5,000	4,000	
				±50	_	15~1.5M	15~1.5M	10~1.5M	10~1.5M					
				±100	_	_	_	10~1.5M	10~1.5M					
				±5	100~300k	100~300k	_	_	_	200V	400V	-	5,000	4,000
			5°C 110°C	±10	47~300k	47~300k	47~300k	47~300k	47~300k					
2B	2B 0.25W 85℃	85°C		±25	47~300k	15~1M	15~1M	10~1M	10~1M					
				±50	-	15~1M	15~1M	10~1M	10~1M					
				±100	_	_	_	10~1M	10~1M					
	2E 0.25W 85°C		85℃ 110℃	±10	100~510k	100~510k	100~510k	100~510k	100~510k	200V	400V	-	5,000	4,000
25		85°C		±25	51~510k	15~1M	15~1M	10~1M	10~1M					
ZE				±50	-	15~1M	15~1M	10~1M	10~1M					
			±100	_	_	_	10~1M	10~1M]					

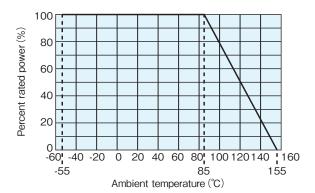
Operating Temperature Range : $-55^{\circ}\text{C} \sim +155^{\circ}\text{C}$

Rated voltage= $\sqrt{\text{Power Rating} \times \text{Resistance value}}$ or Max. working voltage, whichever is lower.

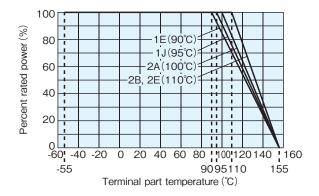
If any questions arise whether to use the "Rated Ambient Temperature" or the "Rated Terminal Part Temperature" in your usage conditions, please give priority to the "Rated Terminal Part Temperature". For more details, please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog.



■Derating Curve



For resistors operated at an ambient temperature of $85^\circ\!\mathrm{C}$ or higher, the power shall be derated in accordance with the above derating curve.



When the terminal part temperature of the resistor exceeds the rated terminal part temperature shown above, the power shall be derated according to the derating curve.

*Please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog before use.

■Performance

Test Items	Performance Requirements $\Delta R \pm (\% + 0.05 \Omega)$		Test Methods				
	Limit	Typical					
Resistance	Within specified tolerance	_	25°C				
T.C.R.	Within specified T.C.R.	_	+25°C/+125°C: T.C.R.=±5(×10 ⁻⁶ /K) +25°C/-55°C and +25°C/+155°C: others				
Overload (Short time)	0.05	0.01	Rated voltage × 2.5 or Max. overload., whichever is less, for 5s				
Resistance to soldering heat	0.05*1	0.01	260°C±5°C, 10s±1s				
Rapid change of temperature	0.1*1	0.04	1E, 1J, 2A: -55°C (30min.)/+155°C (30min.) 1000 cycles 2B, 2E: -55°C (30min.)/+155°C (30min.) 500 cycles				
Moisture resistance	0.25	0.07	85°C±2°C, 85%±5%RH, 1000h 1.5h ON/0.5h OFF cycle				
Endurance at 85°C	0.1	0.04	85°C±2°C, 1000h 1.5h ON/0.5h OFF cycle				
High temperature exposure	0.25	0.10	+155℃, 1000h				

*1 Depends on resistance value.

■Precautions for Use

- The properly and electrostatically measured taping materials are used for the components, but attention should be paid to the fact that there is some danger the parts absorb on the top tapes to cause a failure in the mounting and the parts are destructed by static electricity (1J, 2A, 2B, 2E: 1kV and more, 1E: 0.5kV and more at Human Body Model 100pF, $1.5k\Omega$) to change the resistance in the conditions of an excessive dryness or after the parts are given vibration for a long time as they are packaged on the tapes. Similarly, care should be given not to apply the excessive static electricity when mounting on the boards.
- Ionic impurities such as flux etc. that are attached to these products or those mounted onto a PCB, negatively affect their moisture resistance, corrosion resistance, etc. The flux may contain ionic substances like chlorine, acid, etc. while perspiration and saliva include ionic impurities like sodium (Na⁺), chlorine (Cl⁻) etc. Therefore these kinds of ionic substances may induce electrical corrosion when they invade into the products. Either thorough washing or using RMA solder and flux are necessary since lead free solder contains ionic substances. Washing process is needed, before putting on moisture proof material in order to prevent electrical corrosion.
- When heat-resistant masking tapes are attached to the chip resistors at the time of mounting and then detached, there is a possibility of exfoliation of the top electrodes. It is known that the heat applied in the mounting process will enhance the adhesion strength of the tape adhesive so please avoid the use. If the use of masking tapes are unavoidable, then please be sure not to attach the tape adhesives directly on the products.
- When high-pressure shower cleaning is implemented, there is a possibility of exfoliation of the top electrodes caused by the water pressure stress so please avoid the implementation.

If the implementation is unavoidable, then please evaluate the products beforehand.